TC642

PWM Fan Speed Controller with FanSense™ Technology

Features

• Temperature Proportional Fan Speed for Acoustic Control and Longer Fan Life
• Efficient PWM Fan Drive
• 3.0V to 5.5V Supply Range:
  - Fan Voltage Independent of TC642 Supply Voltage
  - Supports any Fan Voltage
• FanSense™ Fault Detection Circuits Protect Against Fan Failure and Aid System Testing
• Shutdown Mode for "Green" Systems
• Supports Low Cost NTC/PTC Thermistors
• Space Saving 8-Pin MSOP Package
• Over-temperature Indication

Applications

• Power Supplies
• Personal Computers
• File Servers
• Telecom Equipment
• UPSs, Power Amps, etc.
• General Purpose Fan Speed Control

Available Tools

• Fan Controller Demonstration Board (TC642DEMO)
• Fan Controller Evaluation Kit (TC642EV)

Package Types

<table>
<thead>
<tr>
<th>SOIC/PDIP/MSOP</th>
</tr>
</thead>
<tbody>
<tr>
<td>pins</td>
</tr>
<tr>
<td>---</td>
</tr>
<tr>
<td>1</td>
</tr>
<tr>
<td>2</td>
</tr>
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<td>3</td>
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<td>4</td>
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<td>5</td>
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<td>6</td>
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<td>7</td>
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<td>8</td>
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</table>

General Description

The TC642 is a switch mode fan speed controller for use with brushless DC fans. Temperature proportional speed control is accomplished using pulse width modulation (PWM). A thermistor (or other voltage output temperature sensor) connected to the VIN input furnishes the required control voltage of 1.25V to 2.65V (typical) for 0% to 100% PWM duty cycle. Minimum fan speed is set by a simple resistor divider on the V_MIN input. An integrated Start-up Timer ensures reliable motor start-up at turn-on, coming out of shutdown mode or following a transient fault. A logic low applied to V_MIN (Pin 3) causes fan shutdown.

The TC642 also features Microchip Technology’s proprietary FanSense™ technology for increasing system reliability. In normal fan operation, a pulse train is present at SENSE (Pin 5). A missing pulse detector monitors this pin during fan operation. A stalled, open or unconnected fan causes the TC642 to trigger its Start-up Timer once. If the fault persists, the FAULT output goes low and the device is latched in its shutdown mode. FAULT is also asserted if the PWM reaches 100% duty cycle, indicating a possible thermal runaway situation, although the fan continues to run. See Section 5.0, “Typical Applications”, for more information and system design guidelines.

The TC642 is available in the standard 8-pin plastic DIP, SOIC and MSOP packages and is available in the commercial, extended commercial and industrial temperature ranges.
Functional Block Diagram

- **VIN**
- **VOUT**
- **VDD**
- **FAULT**
- **VSHDN**
- **VSSH**
- **GND**
- **C_F**
- **VOUT**
- **TC642**
- **3 x TPWM Timer**
- **Start-up Timer**
- **Missing Pulse Detect**
- **Control Logic**
- **70mV (typ.)**
- **10kΩ**
- **SENSE**

**Pin Descriptions**

- **V_MIN**
- **V_OUT**
- **VDD**
- **VSHDN**
- **VDD**
- **C_F**
- **VSSH**
- **GND**
- **70mV (typ.)**
- **10kΩ**
- **SENSE**

**Key Components**

- **Control Logic**
- **3 x TPWM Timer**
- **Start-up Timer**
- **Missing Pulse Detect**

**Functional Description**

- The TC642 is a functional block diagram that includes control logic, a clock generator, three times TPWM timer, start-up timer, missing pulse detect, and other key components.

**Key Features**

- The diagram illustrates the flow of signals and connections between different components, showing how the TC642 operates in a circuit.
1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

Supply Voltage .........................................................6V
Input Voltage, Any Pin.... (GND – 0.3V) to (VDD +0.3V)
Package Thermal Resistance:
  PDIP (RθJA) ............................................. 125°C/W
  SOIC (RθJA) ............................................ 155°C/W
  MSOP (RθJA) .......................................... 200°C/W
Specified Temperature Range............-40°C to +125°C
Storage Temperature Range.............. -65°C to +150°C

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL SPECIFICATIONS

Electrical Characteristics: TMIN < TA < TMAX. VDD = 3.0V to 5.5V, unless otherwise specified.

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
<th>Test Conditions</th>
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<tr>
<td>VDD</td>
<td>Supply Voltage</td>
<td>3.0</td>
<td>—</td>
<td>5.5</td>
<td>V</td>
<td>Pins 6, 7 Open, CF = 1 µF, VIN = VC(MAX)</td>
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<tr>
<td>IDD</td>
<td>Supply Current, Operating</td>
<td>—</td>
<td>0.5</td>
<td>1.0</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>IDD(SHDN)</td>
<td>Supply Current, Shutdown Mode</td>
<td>—</td>
<td>25</td>
<td>—</td>
<td>µA</td>
<td>Pins 6, 7 Open, CF = 1 µF, VMIN = 0.35V, Note 1</td>
</tr>
<tr>
<td>IIN</td>
<td>VIN, VMIN Input Leakage</td>
<td>-1.0</td>
<td>—</td>
<td>+1.0</td>
<td>µA</td>
<td>Note 1</td>
</tr>
<tr>
<td>VOUT</td>
<td>Output</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>IOL</td>
<td>Sink Current at VOUT Output</td>
<td>1.0</td>
<td>—</td>
<td>—</td>
<td>mA</td>
<td>VDD x 10% of VDD</td>
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<tr>
<td>IOH</td>
<td>Source Current at VOUT Output</td>
<td>5.0</td>
<td>—</td>
<td>—</td>
<td>mA</td>
<td>VDD x 80% of VDD</td>
</tr>
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<td>VIN, VMIN Inputs</td>
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<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
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<tr>
<td>V(AMI), VOTF</td>
<td>Input Voltage at VIN or VMIN for 100% PWM Duty Cycle</td>
<td>2.5</td>
<td>2.65</td>
<td>2.8</td>
<td>V</td>
<td></td>
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<tr>
<td>V(CSPAN)</td>
<td>VC(MAX) - VC(MIN)</td>
<td>1.3</td>
<td>1.4</td>
<td>1.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>VSHDN</td>
<td>Voltage Applied to VMIN to ensure Shutdown Mode</td>
<td>—</td>
<td>—</td>
<td>VDD x 0.13</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>VREL</td>
<td>Voltage Applied to VMIN to Release Shutdown Mode</td>
<td>VDD x 0.19</td>
<td>—</td>
<td>—</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Pulse Width Modulator</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
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<tr>
<td>FPWM</td>
<td>PWM Frequency</td>
<td>26</td>
<td>30</td>
<td>34</td>
<td>Hz</td>
<td>CF = 1.0 µF</td>
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<tr>
<td>SENSE Input</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
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<tr>
<td>VTH(SENSE)</td>
<td>SENSE Input Threshold Voltage with Respect to GND</td>
<td>50</td>
<td>70</td>
<td>90</td>
<td>mV</td>
<td>Note 1</td>
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<td>FAULT Output</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VUL</td>
<td>Output Low Voltage</td>
<td>—</td>
<td>—</td>
<td>0.3</td>
<td>V</td>
<td>IOL = 2.5 mA</td>
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<tr>
<td>IMP</td>
<td>Missing Pulse Detector Timer</td>
<td>—</td>
<td>32/F</td>
<td>—</td>
<td>Sec</td>
<td></td>
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<tr>
<td>ISTARTUP</td>
<td>Start-up Timer</td>
<td>—</td>
<td>32/F</td>
<td>—</td>
<td>Sec</td>
<td></td>
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<td>IDIAG</td>
<td>Diagnostic Timer</td>
<td>—</td>
<td>3/F</td>
<td>—</td>
<td>Sec</td>
<td></td>
</tr>
</tbody>
</table>

Note 1: Ensured by Design, not tested.
2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Symbol</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>$V_{IN}$</td>
<td>Analog Input</td>
</tr>
<tr>
<td>2</td>
<td>$C_F$</td>
<td>Analog Output</td>
</tr>
<tr>
<td>3</td>
<td>$V_{MIN}$</td>
<td>Analog Input</td>
</tr>
<tr>
<td>4</td>
<td>GND</td>
<td>Ground Terminal</td>
</tr>
<tr>
<td>5</td>
<td>SENSE</td>
<td>Analog Input</td>
</tr>
<tr>
<td>6</td>
<td>FAULT</td>
<td>Digital (Open Collector) Output</td>
</tr>
<tr>
<td>7</td>
<td>$V_{OUT}$</td>
<td>Digital Output</td>
</tr>
<tr>
<td>8</td>
<td>$V_{DD}$</td>
<td>Power Supply Input</td>
</tr>
</tbody>
</table>

2.1 Analog Input ($V_{IN}$)

The thermistor network (or other temperature sensor) connects to the $V_{IN}$ input. A voltage range of 1.25V to 2.65V (typical) on this pin drives an active duty cycle of 0% to 100% on the $V_{OUT}$ pin.

2.2 Analog Output ($C_F$)

$C_F$ is the positive terminal for the PWM ramp generator timing capacitor. The recommended $C_F$ is 1 µF for 30 Hz PWM operation.

2.3 Analog Input ($V_{MIN}$)

An external resistor divider connected to the $V_{MIN}$ input sets the minimum fan speed by fixing the minimum PWM duty cycle (1.25V to 2.65V = 0% to 100%, typical). The TC642 enters shutdown mode when $V_{MIN} \leq V_{SHDN}$. During shutdown, the FAULT output is inactive and supply current falls to 25 µA (typical). The TC642 exits shutdown mode when $V_{MIN} \geq V_{REL}$ (see Section 5.0, “Typical Applications”).

2.4 Ground (GND)

GND denotes the ground terminal.

2.5 Analog Input (SENSE)

Pulses are detected at the SENSE pin as fan rotation chops the current through a sense resistor. The absence of pulses indicates a fault.

2.6 Digital Output (FAULT)

The FAULT line goes low to indicate a fault condition. When FAULT goes low due to a fan fault condition, the device is latched in shutdown mode until deliberately cleared or until power is cycled. FAULT may be connected to $V_{MIN}$ if a hard shutdown is desired. FAULT will also be asserted when the PWM reaches 100% duty cycle, indicating that maximum cooling capability has been reached and a possible over-temperature condition may occur. This is a non-latching state and the FAULT output will go high when the PWM duty cycle goes below 100%.

2.7 Digital Output ($V_{OUT}$)

$V_{OUT}$ is an active high complimentary output that drives the base of an external NPN transistor (via an appropriate base resistor) or the gate of an N-channel MOSFET. This output has asymmetrical drive (see Section 1.0, “Electrical Characteristics”).

2.8 Power Supply Input ($V_{DD}$)

$V_{DD}$ may be independent of the fan’s power supply (see Section 1.0, “Electrical Characteristics”).
3.0 DETAILED DESCRIPTION

3.1 PWM

The PWM circuit consists of a ramp generator and threshold detector. The frequency of the PWM is determined by the value of the capacitor connected to the CF input. A frequency of 30 Hz is recommended (CF = 1 μF). The PWM is also the time base for the Start-up Timer (see Section 3.4, “Start-Up Timer”). The PWM voltage control range is 1.25V to 2.65V (typical) for 0% to 100% output duty cycle.

3.2 FAULT Output

The TC642 detects faults in two ways. First, pulses appearing at SENSE due to the PWM turning on are blanked, with the remaining pulses filtered by a missing pulse detector. If consecutive pulses are not detected for 32 PWM cycles (≈1 Sec if CF = 1 μF), the Diagnostic Timer is activated, and VOUT is driven high continuously for three PWM cycles (≈100 msec if CF = 1 μF). If a pulse is not detected within this window, the Start-up Timer is triggered (see Section 3.4). This should clear a transient fault condition. If the missing pulse detector times out again, the PWM is stopped and FAULT goes low. When FAULT is activated due to this condition, the device is latched in shutdown mode and will remain off indefinitely.

The TC642 may be configured to continuously attempt fan restarts, if so desired.

Continuous restart mode is enabled by connecting the FAULT output to VMIN through a 0.01 μF capacitor, as shown in Figure 3-1. When connected in this manner, the TC642 automatically attempts to restart the fan every time a fault condition occurs. When the FAULT output is driven low, the VMIN input is momentarily pulled below VSHDN, initiating a reset and clearing the fault condition. Normal fan start-up is then attempted as previously described. The FAULT output may be connected to external logic (or the interrupt input of a microcontroller) to shut the TC642 down if multiple fault pulses are detected at approximately one second intervals. Diode D1, capacitor C1 and resistors R5 and R6 are provided to ensure fan restarts are the result of a fan fault and not an over-temperature fault. A CMOS logic OR gate may be substituted for these components, if available.

Note: At this point, action must be taken to restart the fan by momentarily pulling VMIN below VSHDN, or cycling system power. In either case, the fan cannot remain disabled due to a fault condition, as severe system damage could result. If the fan cannot be restarted, the system should be shut down.

FIGURE 3-1: Fan Fault Output Circuit.

```
*The parallel combination of R3 and R4 must be >10 kΩ.
```
The second condition by which the TC642 detects a fault is when the PWM control voltage applied to \( V_{\text{IN}} \) becomes greater than that needed to drive 100% duty cycle (see Section 1.0, “Electrical Characteristics”). This indicates that the fan is at maximum drive and the potential exists for system overheating. Either heat dissipation in the system has gone beyond the cooling system’s design limits or some subtle fault exists (such as fan bearing failure or an airflow obstruction). This output may be treated as a system overheat warning and be used to trigger system shutdown. However, in this case, the fan will continue to run even when FAULT is asserted. If a shutdown is desired, FAULT may be connected to \( V_{\text{MIN}} \) outside the device. This will latch the TC642 in shutdown mode when any fault occurs.

### 3.3 \( V_{\text{OUT}} \) Output

The \( V_{\text{OUT}} \) pin is designed to drive a low cost transistor or MOSFET as the low side power switching element in the system. Various examples of driver circuits will be shown throughout this data sheet. This output has asymmetric complementary drive and is optimized for driving NPN transistors or N-channel MOSFETs. Since the system relies on PWM rather than linear control, the power dissipation in the power switch is kept to a minimum. Generally, very small devices (TO-92 or SOT packages) will suffice.

### 3.4 Start-Up Timer

To ensure reliable fan start-up, the Start-up Timer turns the \( V_{\text{OUT}} \) output on for 32 cycles of the PWM whenever the fan is started from the off state. This occurs at power-up and when coming out of shutdown mode. If the PWM frequency is 30 Hz (\( C_F = 1 \mu F \)), the resulting start-up time will be approximately one second. If a fault is detected, the Diagnostic Timer is triggered once, followed by the Start-up Timer. If the fault persists, the device is shut down (see Section 3.2, “FAULT Output”).

### 3.5 Shutdown Control (Optional)

If \( V_{\text{MIN}} \) (Pin 3) is pulled below \( V_{\text{SHDN}} \), the TC642 will go into shutdown mode. This can be accomplished by driving \( V_{\text{MIN}} \) with an open-drain logic signal or by using an external transistor, as shown in Figure 3-1. All functions are suspended until the voltage on \( V_{\text{MIN}} \) becomes higher than \( V_{\text{REL}} \) (0.85\% of \( V_{\text{DD}} \)). Pulling \( V_{\text{MIN}} \) below \( V_{\text{SHDN}} \) will always result in complete device shutdown and reset. The FAULT output is unconditionally inactive in shutdown mode.

A small amount of hysteresis, typically one percent of \( V_{\text{DD}} \) (50 mV at \( V_{\text{DD}} = 5.0\% \)), is designed into the \( V_{\text{SHDN}} \) and \( V_{\text{REL}} \) thresholds. The levels specified for \( V_{\text{SHDN}} \) and \( V_{\text{REL}} \) in Section 1.0, “Electrical Characteristics”, include this hysteresis, plus adequate margin to account for normal variations in the absolute value of the threshold and hysteresis.

### 3.6 SENSE Input

(FanSense™ Technology)

The SENSE input (Pin 5) is connected to a low value current sensing resistor in the ground return leg of the fan circuit. During normal fan operation, commutation occurs as each pole of the fan is energized. This causes brief interruptions in the fan current, seen as pulses across the sense resistor. If the device is not in shutdown mode, and pulses are not appearing at the SENSE input, a fault exists.

The short, rapid change in fan current (high \( \text{dI}/\text{dt} \)) causes a corresponding \( \text{dV}/\text{dt} \) across the sense resistor, \( R_{\text{SENSE}} \). The waveform on \( R_{\text{SENSE}} \) is differentiated and converted to a logic-level pulse-train by \( C_{\text{SENSE}} \) and the internal signal processing circuitry. The presence and frequency of this pulse-train is a direct indication of fan operation (see Section 5.0, “Typical Applications”, for more details).
4.0 SYSTEM BEHAVIOR

The flowcharts describing the TC642’s behavioral algorithm are shown in Figure 4-1. They can be summarized as follows:

4.1 Power-Up

(1) Assuming the device is not being held in shutdown mode (V_{MIN} > V_{REL})...
(2) Turn V_{OUT} output on for 32 cycles of the PWM clock. This ensures that the fan will start from a dead stop.
(3) During this Start-up Timer, if a fan pulse is detected, branch to Normal Operation; if none are received...
(4) Activate the 32-cycle Start-up Timer one more time and look for a fan pulse; if a fan pulse is detected, proceed to Normal Operation; if none are received...
(5) Proceed to Fan Fault.
(6) End.

4.2 Normal Operation

Normal Operation is an endless loop which may only be exited by entering shutdown mode or Fan Fault. The loop can be thought of as executing at the frequency of the oscillator and PWM.

(1) Reset the missing pulse detector.
(2) Is TC642 in shutdown? If so...
   a. V_{OUT} duty cycle goes to zero.
   b. FAULT is disabled.
   c. Exit the loop and wait for V_{MIN} > V_{REL} to resume operation (indistinguishable from power-up).
(3) If an over-temperature fault occurs (V_{IN} > V_{OTF}), activate FAULT; release FAULT when V_{IN} < V_{OTF}.
(4) Drive V_{OUT} to a duty cycle proportional to the greater of V_{IN} and V_{MIN} on a cycle by cycle basis.
(5) If a fan pulse is detected, branch back to the start of the loop (1).
(6) If the missing pulse detector times out ...
(7) Activate the 3-cycle Diagnostic Timer and look for pulses; if a fan pulse is detected, branch back to the start of the loop (1); if none are received...
(8) Activate the 32-cycle Start-up Timer and look for pulses; if a fan pulse is detected, branch back to the start of the loop (1); if none are received...
(9) Quit Normal Operation and go to Fan Fault.
(10) End.

4.3 Fan Fault

Fan fault is an infinite loop wherein the TC642 is latched in shutdown mode. This mode can only be released by a reset (i.e., V_{MIN} being brought below V_{SHDN}, then above V_{REL}, or by power-cycling).

(1) While in this state, FAULT is latched on (low) and the V_{OUT} output is disabled.
(2) A reset sequence applied to the V_{MIN} pin will exit the loop to Power-Up.
(3) End.
FIGURE 4-1: TC642 Behavioral Algorithm Flowchart.
5.0 **TYPICAL APPLICATIONS**

Designing with the TC642 involves the following:

1. The temp sensor network must be configured to deliver 1.25V to 2.65V on VIN for 0% to 100% of the temperature range to be regulated.
2. The minimum fan speed (V\textsubscript{MIN}) must be set.
3. The output drive transistor and associated circuitry must be selected.
4. The SENSE network, R\textsubscript{SENSE} and C\textsubscript{SENSE}, must be designed for maximum efficiency, while delivering adequate signal amplitude.
5. If shutdown capability is desired, the drive requirements of the external signal or circuit must be considered.

The TC642 demonstration and prototyping board (TC642DEMO), and the TC642 Evaluation Kit (TC642EV), provide working examples of TC642 circuits and prototyping aids. The TC642DEMO is a printed circuit board optimized for small size and ease of inclusion into system prototypes. The TC642EV is a larger board intended for benchtop development and analysis. At the very least, anyone contemplating a design using the TC642 should consult the documentation for both TC642EV (DS21403) and TC642DEMO (DS21401).

![Typical Application Circuit](image)

**FIGURE 5-1:** Typical Application Circuit.

### 5.1 Temperature Sensor Design

The temperature signal connected to VIN must output a voltage in the range of 1.25V to 2.65V (typical) for 0% to 100% of the temperature range of interest. The circuit in Figure 5-2 illustrates a convenient way to provide this signal.

Figure 5-2 shows a simple temperature dependent voltage divider circuit. RT\textsubscript{1} is a conventional NTC thermistor while R\textsubscript{1} and R\textsubscript{2} are standard resistors. The supply voltage, V\textsubscript{DD}, is divided between R\textsubscript{2} and the parallel combination of RT\textsubscript{1} and R\textsubscript{1} (for convenience, the parallel combination of RT\textsubscript{1} and R\textsubscript{1} will be referred to as R\textsubscript{TEMP}). The resistance of the thermistor at various temperatures is obtained from the manufacturer’s specifications. Thermistors are often referred to in terms of their resistance at 25°C.
FIGURE 5-2: Temperature Sensing Circuit.

Generally, the thermistor shown in Figure 5-2 is a nonlinear device with a negative temperature coefficient (also called an NTC thermistor). In Figure 5-2, Ri is used to linearize the thermistor temperature response, while R2 is used to produce a positive temperature coefficient at the VIN node. As an added benefit, this configuration produces an output voltage delta of 1.4V, which is well within the range of the Vc(SPAN) specification of the TC642. A 100 kΩ NTC thermistor is selected for this application in order to keep IDIV at a minimum.

For the voltage range at VIN to be equal to 1.25V to 2.65V, the temperature range of this configuration is 0°C to 50°C. If a different temperature range is required from this circuit, Ri should be chosen to equal the resistance value of the thermistor at the center of this new temperature range. With this change, R2 is adjusted according to the formulas below. It is suggested that a maximum temperature range of 50°C be used with this circuit due to thermistor linearity limitations.

The following two equations permit solving for the two unknown variables, Ri and R2. More information regarding thermistors can be found in AN679, “Temperature Sensing Technologies”, and AN685, “Thermistors in Single Supply Temperature Sensing Circuits”, which can be downloaded from Microchip’s web site at: www.microchip.com.

EQUATION

\[
\frac{V_{DD} \times R_2}{R_{TEMP} (T_i) + R_2} = V(T_1)
\]

\[
\frac{V_{DD} \times R_2}{R_{TEMP} (T_2) + R_2} = V(T_2)
\]

Where T1 and T2 are the chosen temperatures and RTEMP is the parallel combination of the thermistor and Ri.

5.2 Minimum Fan Speed

A voltage divider on VMIN sets the minimum PWM duty cycle and, thus, the minimum fan speed. As with the VIN input, 1.25V to 2.65V typically corresponds to 0% to 100% duty cycle. Assuming that fan speed is linearly related to duty cycle, the minimum speed voltage is given by the equation:

EQUATION

\[
V_{MIN} = \frac{\text{Minimum Speed}}{\text{Full Speed}} \times (1.4) + 1.25V
\]

For example, if 2500 RPM equates to 100% fan speed, and a minimum speed of 1000 RPM is desired, then the VMIN voltage is:

EQUATION

\[
V_{MIN} = \frac{1000}{2500} \times (1.4) + 1.25V = 1.81V
\]

The VMIN voltage may be set using a simple resistor divider, as shown in Figure 5-3. Per Section 1.0, “Electrical Characteristics”, the leakage current at the VMIN pin is no more than 1 µA. It would be very conservative to design for a divider current, IDIV, of 100 µA. If VDD = 5.0V then;

EQUATION

\[
IDIV = 100\mu A = \frac{5.0V}{R_1 + R_2}, \text{ therefore}
R_1 + R_2 = \frac{5.0V}{100\mu A} = 50,000\Omega = 50k\Omega
\]
We can further specify \( R_1 \) and \( R_2 \) by the condition that the divider voltage is equal to our desired \( V_{\text{MIN}} \). This yields the following equation:

\[
V_{\text{MIN}} = \frac{V_{\text{DD}} \cdot R_2}{R_1 + R_2}
\]

Solving for the relationship between \( R_1 \) and \( R_2 \) results in the following equation:

\[
R_1 = R_2 \times \frac{V_{\text{DD}} - V_{\text{MIN}}}{V_{\text{MIN}}}
\]

In this example, \( R_1 = (1.762) \times R_2 \). Substituting this relationship back into the previous equation yields the resistor values:

\[ R_2 = 18.1 \text{ k}\Omega, \quad \text{and} \quad R_1 = 31.9 \text{ k}\Omega \]

In this case, the standard values of 31.6 k\( \Omega \) and 18.2 k\( \Omega \) are very close to the calculated values and would be more than adequate.

5.3 Operations at Low Duty Cycle

One boundary condition which may impact the selection of the minimum fan speed is the irregular activation of the Diagnostic Timer due to the TC642 "missing" fan commutation pulses at low speeds. This is a natural consequence of low PWM duty cycles (typically 25% or less). Recall that the SENSE function detects commutation of the fan as disturbances in the current through \( R_{\text{SENSE}} \). These can only occur when the fan is energized (i.e., \( V_{\text{OUT}} \) is "on"). At very low duty cycles, the \( V_{\text{OUT}} \) output is "off" most of the time. The fan may be rotating normally, but the commutation events are occurring during the PWM's off-time.

The phase relationship between the fan's commutation and the PWM edges tends to "walk around" as the system operates. At certain points, the TC642 may fail to capture a pulse within the 32-cycle missing pulse detector window. When this happens, the 3-cycle Diagnostic Timer will be activated, the \( V_{\text{OUT}} \) output will be active continuously for three cycles and, if the fan is operating normally, a pulse will be detected. If all is well, the system will return to normal operation. There is no harm in this behavior, but it may be audible to the user as the fan accelerates briefly when the Diagnostic Timer fires. For this reason, it is recommended that \( V_{\text{MIN}} \) be set no lower than 1.8V.

5.4 FanSense Network

\((R_{\text{SENSE}} \text{ and } C_{\text{SENSE}})\)

The FanSense network, comprised of \( R_{\text{SENSE}} \) and \( C_{\text{SENSE}} \), allows the TC642 to detect commutation of the fan motor (FanSense technology). This network can be thought of as a differentiator and threshold detector. The function of \( R_{\text{SENSE}} \) is to convert the fan current into a voltage. \( C_{\text{SENSE}} \) serves to AC-couple this voltage signal and provide a ground-referenced input to the SENSE pin. Designing a proper SENSE network is simply a matter of scaling \( R_{\text{SENSE}} \) to provide the necessary amount of gain (i.e., the current-to-voltage conversion ratio). A 0.1 \( \mu \text{F} \) ceramic capacitor is recommended for \( C_{\text{SENSE}} \): Smaller values require larger sense resistors, and higher value capacitors are bulkier and more expensive. Using a 0.1 \( \mu \text{F} \) capacitor results in reasonable values for \( R_{\text{SENSE}} \). Figure 5-4 illustrates a typical SENSE network. Figure 5-5 shows the waveforms observed using a typical SENSE network.
Table 5-1 lists recommended values for $R_{\text{SENSE}}$ based on the nominal operating current of the fan. Note that the current draw specified by the fan manufacturer may be a worst-case rating for near-stall conditions and may not be the fan’s nominal operating current. The values in Table 5-1 refer to actual average operating current. If the fan current falls between two of the values listed, use the higher resistor value. The end result of employing Table 5-1 is that the signal developed across the sense resistor is approximately 450 mV in amplitude.

**TABLE 5-1: $R_{\text{SENSE}}$ VS. FAN CURRENT**

<table>
<thead>
<tr>
<th>Nominal Fan Current (mA)</th>
<th>$R_{\text{SENSE}}$ ($\Omega$)</th>
</tr>
</thead>
<tbody>
<tr>
<td>50</td>
<td>9.1</td>
</tr>
<tr>
<td>100</td>
<td>4.7</td>
</tr>
<tr>
<td>150</td>
<td>3.0</td>
</tr>
<tr>
<td>200</td>
<td>2.4</td>
</tr>
<tr>
<td>250</td>
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<td>1.8</td>
</tr>
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<td>350</td>
<td>1.5</td>
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<tr>
<td>400</td>
<td>1.3</td>
</tr>
<tr>
<td>450</td>
<td>1.2</td>
</tr>
<tr>
<td>500</td>
<td>1.0</td>
</tr>
</tbody>
</table>

**5.5 Output Drive Transistor Selection**

The TC642 is designed to drive an external transistor or MOSFET for modulating power to the fan. This is shown as Q1 in Figures 3-1, 5-1, 5-4, 5-6, 5-7, 5-8 and 5-9. The $V_{\text{OUT}}$ pin has a minimum source current of 5 mA and a minimum sink current of 1 mA. Bipolar transistors or MOSFETs may be used as the power switching element, as shown in Figure 5-7. When high current gain is needed to drive larger fans, two transistors may be used in a Darlington configuration. Three possible circuit topologies are shown in Figure 5-7: (a) shows a single NPN transistor used as the switching element; (b) illustrates the Darlington pair; and (c) shows an N-channel MOSFET.

One major advantage of the TC642’s PWM control scheme versus linear speed control is that the power dissipation in the pass element is kept very low. Generally, low cost devices in very small packages, such as TO-92 or SOT, can be used effectively. For fans with nominal operating currents of no more than 200 mA, a single transistor usually suffices. Above 200 mA, the Darlington or MOSFET solution is recommended. For the fan sensing function to work correctly, it is imperative that the pass transistor be fully saturated when “on”.

Table 5-2 gives examples of some commonly available transistors and MOSFETs. This table should be used as a guide only since there are many transistors and MOSFETs which will work just as well as those listed. The critical issues when choosing a device to use as Q1 are: (1) the breakdown voltage ($V_{\text{BRCEO}}$ or $V_{\text{DS}}$ (MOSFET)) must be large enough to withstand the highest voltage applied to the fan (Note: This will occur when the fan is off); (2) 5 mA of base drive current must be enough to saturate the transistor when conducting the full fan current (transistor must have sufficient gain); (3) the $V_{\text{OUT}}$ voltage must be high enough to sufficiently drive the gate of the MOSFET to minimize the $R_{\text{DS(on)}}$ of the device; (4) rated fan current draw must be within the transistor’s/MOSFET’s current handling capability; and (5) power dissipation must be kept within the limits of the chosen device.

A base-current limiting resistor is required with bipolar transistors (Figure 5-6).

---

**FIGURE 5-6: Circuit For Determining $R_{\text{BASE}}$.**

The correct value for this resistor can be determined as follows:

$$V_{\text{OH}} = V_{\text{RSENSE}} + V_{\text{BE(SAT)}} + V_{\text{RBASE}}$$

$$V_{\text{RSENSE}} = I_{\text{FAN}} \times R_{\text{SENSE}}$$

$$V_{\text{RBASE}} = R_{\text{BASE}} \times I_{\text{BASE}}$$

$$I_{\text{BASE}} = \frac{I_{\text{FAN}}}{h_{FE}}$$

$V_{\text{OH}}$ is specified as 80% of $V_{\text{DD}}$ in Section 1.0, “Electrical Characteristics”; $V_{\text{BE(SAT)}}$ is given in the chosen transistor’s data sheet. It is now possible to solve for $R_{\text{BASE}}$.

**EQUATION**

$$R_{\text{BASE}} = \frac{V_{\text{OH}} \times V_{\text{BE(SAT)}} \times V_{\text{RSENSE}}}{I_{\text{BASE}}}$$
Some applications require the fan to be powered from the negative 12V supply to keep motor noise out of the positive voltage power supplies. As is shown in Figure 5-8, zener diode D1 offsets the -12V power supply voltage, holding transistor Q1 off when V\text{OUT} is low. When V\text{OUT} is high, the voltage at the anode of D1 increases by V\text{OUT}, causing Q1 to turn on. Operation is otherwise consistent with the case of fan operation from +12V.

**FIGURE 5-7:** Output Drive Transistor Circuit Topologies.

- **a)** Single Bipolar Transistor
- **b)** Darlington Transistor Pair
- **c)** N-Channel MOSFET

**FIGURE 5-8:** Powering the Fan From a -12V Supply.

*Note: Value depends on the specific application and is shown for example only.*
TABLE 5-2: TRANSISTORS AND MOSFETS FOR Q₁ (V_DD = 5V)

<table>
<thead>
<tr>
<th>Device</th>
<th>Package</th>
<th>Max. V_{BE(sat)}/V_{GS} (V)</th>
<th>Min. H_{FE}</th>
<th>V_{CEO}/V_{DS} (V)</th>
<th>Fan Current (mA)</th>
<th>Suggested R_{BASE} (Ω)</th>
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</thead>
<tbody>
<tr>
<td>MMBT2222A</td>
<td>SOT-23</td>
<td>1.2</td>
<td>50</td>
<td>40</td>
<td>150</td>
<td>800</td>
</tr>
<tr>
<td>MPS2222A</td>
<td>TO-92</td>
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<td>50</td>
<td>40</td>
<td>150</td>
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<td>MPS6602</td>
<td>TO-92</td>
<td>1.2</td>
<td>50</td>
<td>40</td>
<td>500</td>
<td>301</td>
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<td>SI2302</td>
<td>SOT-23</td>
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<td>20</td>
<td>500</td>
<td>Note 1</td>
</tr>
<tr>
<td>MGSF1N02E</td>
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<td>SI4410</td>
<td>SO-8</td>
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<td>30</td>
<td>1000</td>
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</tr>
<tr>
<td>SI2308</td>
<td>SOT-23</td>
<td>4.5</td>
<td>NA</td>
<td>60</td>
<td>500</td>
<td>Note 1</td>
</tr>
</tbody>
</table>

Note 1: A series gate resistor may be used in order to control the MOSFET turn-on and turn-off times.

5.6 Latch-up Considerations

As with any CMOS IC, the potential exists for latch-up if signals are applied to the device which are outside the power supply range. This is of particular concern during power-up if the external circuitry (such as the sensor network, V_{MIN} divider or shutdown circuit) is powered by a supply different from that of the TC642. Care should be taken to ensure that the TC642’s V_DD supply powers up first. If possible, the networks attached to V_IN and V_MIN should connect to the V_DD supply at the same physical location as the IC itself. Even if the IC and any external networks are powered by the same supply, physical separation of the connecting points can result in enough parasitic capacitance and/or inductance in the power supply connections to delay one power supply “routing” versus another.
5.7 Power Supply Routing and Bypassing

Noise present on the \( V_{IN} \) and \( V_{MIN} \) inputs may cause erroneous operation of the FAULT output. As a result, these inputs should be bypassed with a 0.01 \( \mu \)F capacitor mounted as close to the package as is possible. This is particularly true of \( V_{IN} \), which is usually driven from a high impedance source (such as a thermistor). In addition, the \( V_{DD} \) input should be bypassed with a 1 \( \mu \)F capacitor. Grounds should be kept as short as possible. To keep fan noise off the TC642 ground pin, individual ground returns for the TC642 and the low side of the fan current sense resistor should be used.

**Design Example**

**Step 1.** Calculate \( R_1 \) and \( R_2 \) based on using an NTC having a resistance of 10 \( k\Omega \) at \( T_{MIN} \) (25°C) and 4.65 \( k\Omega \) at \( T_{MAX} \) (45°C) (see Figure 5-9).

\[
R_1 = 20.5 \ k\Omega \\
R_2 = 3.83 \ k\Omega
\]

**Step 2.** Set minimum fan speed \( V_{MIN} = 1.8V \). Limit the divider current to 100 \( \mu \)A from which \( R_5 = 33 \ k\Omega \) and \( R_6 = 18 \ k\Omega \).

**Step 3.** Design the output circuit.

Maximum fan motor current = 250 mA. \( Q_1 \) beta is chosen at 50 from which \( R_7 = 800 \ \Omega \).

---

**FIGURE 5-9:** Design Example.
5.8 TC642 as a Microcontroller Peripheral

In a system containing a microcontroller or other host intelligence, the TC642 can be effectively managed as a CPU peripheral. Routine fan control functions can be performed by the TC642 without processor intervention. The microcontroller receives temperature data from one or more points throughout the system. It calculates a fan operating speed based on an algorithm specifically designed for the application at hand. The processor controls fan speed using complementary port bits I/O1 through I/O3. Resistors R₁ through R₆ (5% tolerance) form a crude 3-bit DAC that translates the 3-bit code from the processor's outputs into a 1.6V DC control signal. A monolithic DAC or digital pot may be used instead of the circuit shown in Figure 5-10.

With \( V_{\text{MIN}} \) set to 1.8V, the TC642 has a minimum operating speed of approximately 40% of full rated speed when the processor's output code is 000[B]. Output codes 001[B] to 111[B] operate the fan from roughly 40% to 100% of full speed. An open-drain output from the processor (I/O0) can be used to reset the TC642 following detection of a fault condition. The FAULT output can be connected to the processor's interrupt input, or to an I/O pin, for polled operation.

![Figure 5-10: TC642 as a Microcontroller Peripheral.](image-url)
6.0 PACKAGING INFORMATION

6.1 Package Marking Information

**Legend:**
- XX...X  Customer specific information*
- YY  Year code (last 2 digits of calendar year)
- WW  Week code (week of January 1 is week '01')
- NNN  Alphanumeric traceability code

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard marking consists of Microchip part number, year code, week code, traceability code (facility code, mask rev#, and assembly code). For marking beyond this, certain price adders apply. Please check with your Microchip Sales Office.
8-Lead Plastic Dual In-line (P) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

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* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-001
Drawing No. C04-018
8-Lead Plastic Small Outline (SN) – Narrow, 150 mil (SOIC)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

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* Controlling Parameter
§ Significant Characteristic

**Notes:**
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.
JEDEC Equivalent: MS-012
Drawing No. C04-057

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8-Lead Plastic Micro Small Outline Package (MS) (MSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

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*Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

Drawing No. C04-111
6.2 Taping Form

**Component Taping Orientation for 8-Pin SOIC (Narrow) Devices**

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**Component Taping Orientation for 8-Pin MSOP Devices**

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7.0 REVISION HISTORY

Revision D (December 2012)

Added a note to each package outline drawing.
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________________________________________________________________________

2. How does this document meet your hardware and software development needs?
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6. Is there any incorrect or misleading information (what and where)?
________________________________________________________________________

7. How would you improve this document?
________________________________________________________________________
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To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

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<td>UA = Plastic Micro Small Outline (MSOP), 8-lead **</td>
</tr>
</tbody>
</table>

Examples:

a) TC642COA: PWM Fan Speed Controller w/ Fault Detection, SOIC package.
b) TC642COA713: PWM Fan Speed Controller w/ Fault Detection, SOIC package, Tape and Reel.
c) TC642CPA: PWM Fan Speed Controller w/ Fault Detection, PDIP package.
d) TC642EUA: PWM Fan Speed Controller w/ Fault Detection, MSOP package.

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